Patent

Case No.: 57993US005

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: YOKOYAMA, CHIKAFUMI

Application No.: 10/518959 Confirmation No.: 5068

Filed: June 20, 2003

Title: FLEXIBLE MOLD AND METHOD OF MANUFACTURING MICROSTRUCTURE

USING SAME

# RESPONSE TO FAILURE TO ACCEPTABLY RESPOND TO NOTICE OF NON-COMPLIANT AMENDMENT

#### CERTIFICATE OF MAILING OR TRANSMISSION [37 CFR § 1.8(a)]

I hereby certify that this correspondence is being:

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 ▼ transmitted to United States Patent and Trademark Office on the date shown below via the Office electronic filing system.

April 15, 2008 /Amber Veenendaal/
Date Signed by: Amber Veenendaal

#### Dear Sir:

This is in response to the Notice of Failure to Acceptably Respond to Notice of Non-Compliant Amendment, dated April 12, 2008, in the above-identified application.

### <u>Fees</u>

- Any required fee will be made at the time of submission via EFS-Web. In the event fees are not or cannot be paid at the time of EFS-Web submission, please charge any fees under 37 CFR § 1.17 which may be required to Deposit Account No. 13-3723.
- Please charge any additional fees associated with the prosecution of this application to Deposit Account No. 13-3723. This authorization includes the fee for any necessary extension of time under 37 CFR § 1.136(a). To the extent any such extension should become necessary, it is hereby requested.
- Please credit any overpayment to the same deposit account.